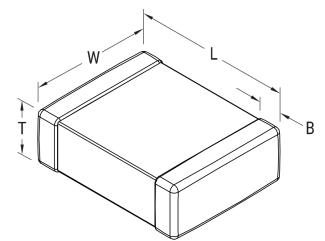


C1206C151FGGACTU

Aliases (C1206C151FGGAC7800)

SMD Comm COG HV, Ceramic, 150 pF, 1%, 2000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1206



Click here for the 3D model.

Dimensions	
Chip Size	1206
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Т	1.6mm +/-0.15mm
В	0.5mm +/-0.25mm

Packaging Specifications	
Packaging T	&R, 180mm, Plastic Tape
Packaging Quantity 2	000

General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	36 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	150 pF
Measurement Condition	1 MHz 1.0Vrms
Capacitance Tolerance	1%
Voltage DC	2000 VDC
Dielectric Withstanding Voltage	2400 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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